APPLICA	BLE STA	NDARD										
Operating temperature		e range	-55 °C to 85 °C	0	Storage tem				-10°C TO 50°C(Packed o	onditi	on)	
RATING	Voltage		30V AC/DC		humidity r		range		Relative humidity 90 % MAX (N		Not dewed)	
	Current		0.2 A Ap		Applica	ble cab	ole		$t=0.2\pm0.02$ mm, Gold	platin	g	
			SPEC	IFICA	1OIT	NS						
IT	EM		TEST METHOD					REQU	IIREMENTS	QT	АТ	
CONSTR	UCTION	1								1	1	
General examination		Visually a	nd by measuring instrumen	nt.		According to drawing.			×	×		
Marking		Confirmed	Confirmed visually.			(note 1)			×	×		
ELECTR	ICAL CHA	ARACTE	RISTICS									
Voltage proof			90 V AC for 1 min.			No breakdown.			×	_		
Insulation resistance		100 V DC	100 V DC.			50 MΩ MIN.				×	-	
Contact resis	stance	AC 20 mV	AC 20 mV MAX , 1 mA .			150 mg	Ω MAX.			×	_	
						Including FPC bulk resistance (L=8mm)						
MECHAN	IICAL CH	IARACTE	RISTICS						•	•	•	
Vibration			Frequency 10 to 55 Hz, half amplitude						ontinuity of 1 μs.	×	-	
Shock			for 10 cycles in 3 axial dire	ections.		_			ce: 150 mΩ MAX.			
OHOUR			981 m/s ² , duration of pulse 6 ms at 3 times in 3 both axial directions.			<u>৩</u> ।۷0	uamage	, crac	k and looseness of parts.	×		
Mechanical operation		10 times				 Contact resistance: 150 mΩ MAX. No damage, crack and looseness of parts. 			×	-		
FPC insertio	n force	Measured	Measured by applicable FPC			Insertion force : Direction of insertion			×	+-		
		`	(Thickness of FPC shall be t=0.20mm at initial condition.)				4.3 N MAX (<i>note 2</i>)					
FPC retention	n force	Measured	Measured by applicable FPC			Retention force : Direction of extraction			×	<u> </u>		
(TI		,	(Thickness of FPC shall be t=0.20mm at initial condition.)			5.2 N MIN (<i>note3</i>)						
		L CHARA	CTERISTICS							1	1	
Rapid chang	e of		Temperature-55→+15 _{TO} +35→+85→+15 _{TO} +35°C			① Contact resistance: 150 mΩ MAX.			×	-		
temperature	temperature		Time $30 \rightarrow 2 \text{ to } 3 \rightarrow 30 \rightarrow 2 \text{ to } 3 \text{ min}$ Under 5 cycles.			② Insulation resistance: 50 MΩ MIN.③ No damage, crack and looseness of parts.						
Damp heat (steady state	e)		Exposed at 40±2 °C, Relative humidity 90 to 95 %, 96 h.							×	_	
Damp heat,			Exposed at -10 to +65 °c,			① Contact resistance: 150 mΩ MAX.				×	T -	
			Relative humidity 90 to 96 %,			② Insulation resistance: 1 MΩ MIN.						
		10 cycles	10 cycles, TOTAL 240 h.				(At high humidity) ③ Insulation resistance: 50 MΩ MIN. (At dry)					
						No damage, crack and looseness of parts						
ĺ												
COUN	т)ESCBIBTIC	ON OF REVISIONS		DESIG	NED			CHECKED	רט	ATE	
A	<u>' </u>	JEOUNIF HU	NEVISIONS		PLSIG	INLU			OHLONED	DF	ΛIĽ	
REMARK				1			APPRO	VED	KN. SHIBUYA	2022	21107	
							CHEC		HH. MURAKAMI		21107	
						DESIGNE		NED			21107	
Unless otherwise specified, re			efer to IEC 60512.			DRAWN		ΝN	SI. MIZUSAWA			
· .				DR	DRAWING NO. ELC-394201-0			0-0	0			
SPECIFICATION SHEET HIROSE ELECTRIC CO., LTD.				PART NO.								
			FI FOTDIO COLLED		CODE				0-5501-0-00		1/2	
			.ELOTRIO GO., ETD. CODE			: NO. ULUDBU-DDUI-			0 0001-0-00	$\overline{\Delta}$	1/2	

	SPECIFICATIO	NS		
ITEM	TEST METHOD	REQUIREMENTS	QT	АТ
Dry heat	Exposed at 85±2°C, 96 h.	① Contact resistance: 150 mΩ MAX.	×	_
Cold	Exposed at -55±3°C, 96 h.	② No damage, crack and looseness of parts	×	_
Sulphur dioxide [JIS C 60068-2-42]	Exposed at 40 ± 2 °C, Relative humidity $80\pm5\%$ 25 ± 5 ppm for 96 h.	① Contact resistance: 150 mΩ MAX.	×	_
Solderability	Soldered at solder temperature, 245±3°C for immersion duration,3±0.3 sec.	A new uniform coating of solder shall cover a minimum of 95 % of the surface being immersed.	×	_
Resistance to soldering heat	1) Reflow soldering: Peak TMP. 250 °C MAX. Reflow TMP. over 220 °C 60 to 90 sec. Number of reflow: 2 times 2) Soldering irons: TMP. 350±10 °C for 5±1 sec.	No deformation of case of excessive looseness of the terminals. (note 4)	×	

(note 1)

This product features top-contact point.

"One Action Lock" completes FPC lock just by inserting the FPC.

Do not operate the locking-lever when inserting the FPC.

(note 2)

Do not insert the FPC to this product at an angle.

(note 3)

Stabilize the FPC to PCB or something fixed, if pull-up or pull-down force is expected to be applied to the FPC.

(note 4)

Blisters which may be generated on the housing do not affect product performance.

Note QT:Q	ualification Test AT:Assurance Test X:Applicable Test	DRAWIN	NG NO.	ELC-394201-00-00		
HS	SPECIFICATION SHEET	PART NO.	FH82-14S-0. 25SHW			
11.0	HIROSE ELECTRIC CO., LTD.	CODE NO	CL058	0-5501-0-00	\triangle	2/2